

TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power (tp = 8/20μs) - See Figure 1	P _{PP}	350	Watts
Operating Temperature	T _A	-55 to 150	°C
Storage Temperature	T _{STG}	-55 to 150	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

PART NUMBER (Note 1 -2)	DEVICE MARKING	RATED STAND-OFF VOLTAGE V _{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA V _(BR) VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ IP = 1A V _C VOLTS	MAXIMUM LEAKAGE CURRENT @ V _{WM} I _D μA	TYPICAL CAPACITANCE @ 0V, 1MHz C pF
GBLC03	3	3.3	4.0	7.0	5	3
GBLC03C	3C	3.3	4.0	7.0	5	3
GBLC05	5	5.0	6.0	9.8	5	3
GBLC05C	5C	5.0	6.0	9.8	5	3
GBLC08	8	8.0	8.5	13.4	2	3
GBLC08C	8C	8.0	8.5	13.4	2	3
GBLC12	2	12.0	13.3	19.0	1	3
GBLC12C	2C	12.0	13.3	19.0	1	3
GBLC15	6	15.0	16.7	24.0	1	3
GBLC15C	6C	15.0	16.7	24.0	1	3
GBLC18	1	18.0	20.0	29.0	1	3
GBLC18C	1C	18.0	20.0	29.0	1	3
GBLC24	4	24.0	26.7	43.0	1	3
GBLC24C	4C	24.0	26.7	43.0	1	3

NOTES

1. Part numbers with an additional "C" suffix are bidirectional devices, i.e., GBLC05C.
2. Unidirectional Only: Positive potential is applied from pin 1 to 2.

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FIGURE 1
PEAK PULSE POWER VS PULSE TIME

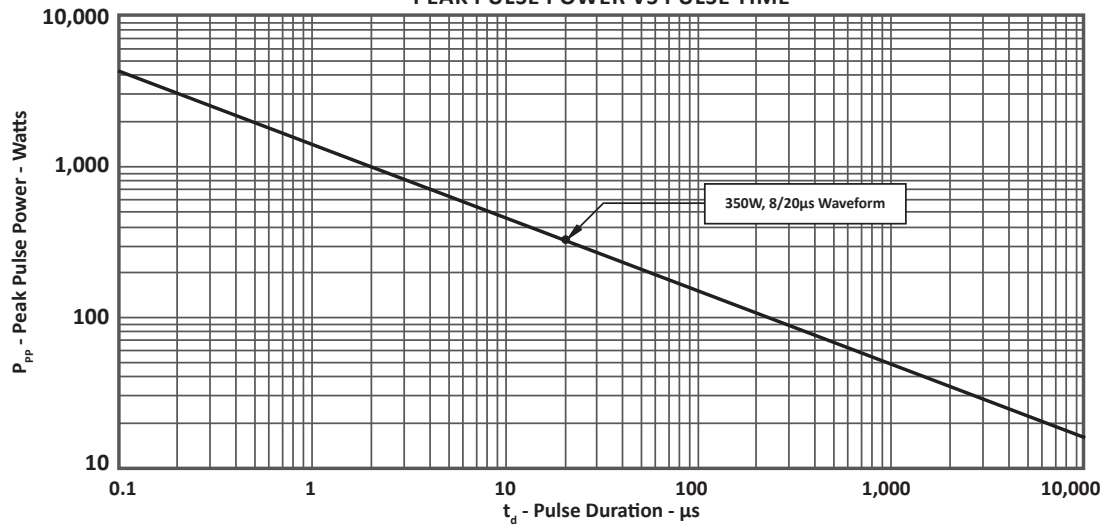
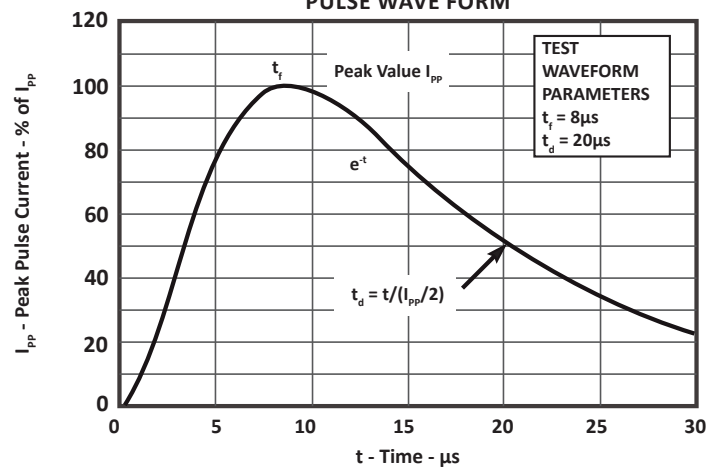
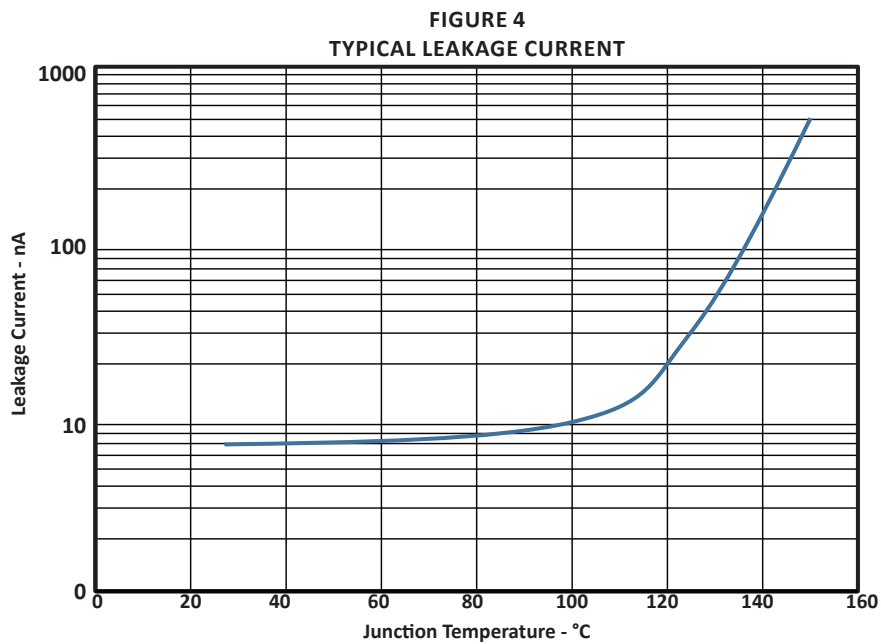
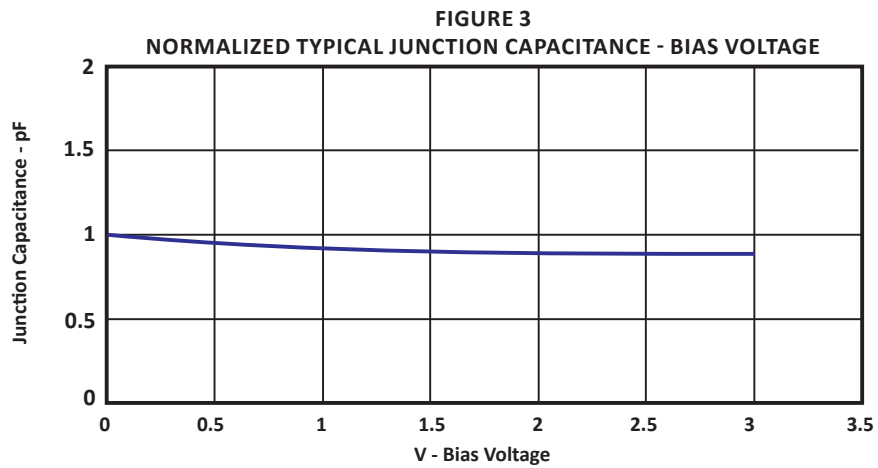
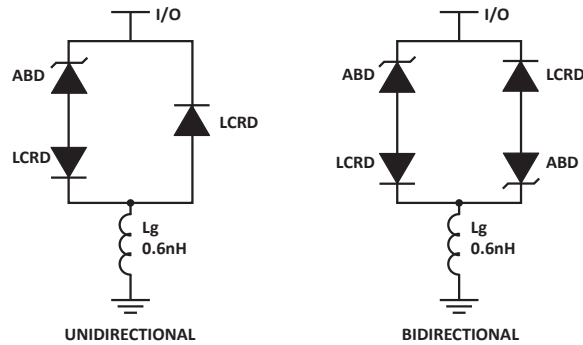


FIGURE 2
PULSE WAVE FORM



TYPICAL DEVICE CHARACTERISTICS

SPICE MODEL

FIGURE 1
SPICE MODEL


ABD - Avalanche Breakdown Diode (TVS)
 LCRD: Low Capacitance Rectifier Diode
 Lg - Lead Inductance

TABLE 1 - SPICE PARAMETERS

PARAMETER	UNIT	ABD(TVS)	LCRD
BV	V	See Table 2	200
IBV	μA	1	0.01
C _{jo}	pF	See Table 2	2
I _s	A	See Table 2	1E-11
V _j	V	0.6	0.6
M	-	0.33	0.33
N	-	1	1
R _s	Ohms	See Table 2	0.75
TT	s	1E-8	1E-9
EG	eV	1.11	1.11

TABLE 2 - ABD SPECIFIC SPICE PARAMETERS

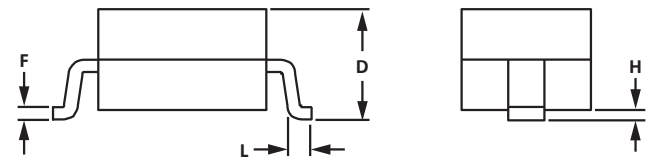
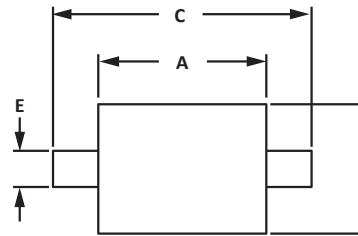
PART NUMBER	B _v (VOLTS)	C _{jo} (pF)	I _s (AMPS)	Rs(OHMS)
GBLC03 & GBLC03C	4.0	10	1E-11	0.21
GBLC05 & GBLC05C	6.0	284	1E-11	0.14
GBLC08 & GBLC08C	8.5	146	1E-11	0.28
GBLC12 & GBLC12C	13.3	123	1E-13	0.40
GBLC15 & GBLC15C	16.7	102	1E-13	0.52
GBLC18 & GBLC18C	20.0	80	1E-13	0.80
GBLC24 & GBLC24C	26.7	61	1E-13	1.54

SOD-323 PACKAGE INFORMATION
OUTLINE DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.60	1.90	0.063	0.075
B	1.15	1.45	0.045	0.057
C	2.39	2.70	0.094	0.106
D	0.80	1.10	0.031	0.043
E	0.25	0.40	0.010	0.016
F	0.10	0.20	0.004	0.008
H	-	0.10	-	0.004
L	0.20	-	0.008	-

NOTES

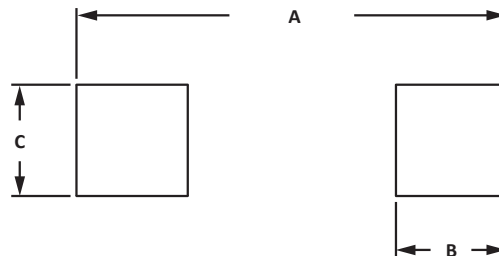
- Controlling dimension: millimeters.
- Dimensioning and tolerances per ANSI Y14.5M, 1985.
- Dimensions are exclusive of mold flash and metal burrs.


PAD LAYOUT DIMENSIONS

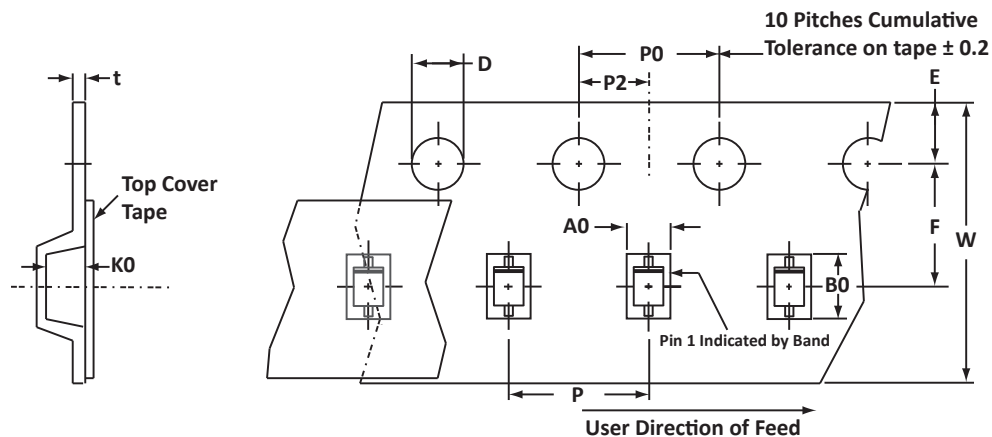
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.87	3.12	0.113	0.123
B	0.66	0.91	0.026	0.036
C	0.66	0.91	0.026	0.036

NOTES

- Controlling dimension: millimeters.



TAPE AND REEL



SPECIFICATIONS

REEL DIA.	TAPE WIDTH	A0	B0	K0	D	E	F	W	P0	P2	P	tmax
178mm (7")	8mm	1.55 ± 0.10	2.90 ± 0.10	1.35 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.30	4.00 ± 0.10	2.00 ± 0.05	4.00 ± 0.10	0.25

NOTES

1. Dimensions are in millimeters.
2. Surface mount product is taped and reeled in accordance with EIA-481.
3. Suffix - T7 = 7" Reel - 3,000 pieces per 8mm tape.
4. Marking on Part - marking code (see page 2), polarity band (Unidirectional Only).

ORDERING INFORMATION

BASE PART NUMBER (xx = Voltage)	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY
GBLCxx/GBLCxxC	-LF	-T7	3,000	7"	n/a

This device is only available in a Lead-Free configuration.

COMPANY INFORMATION

COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is ISO 9001:2015 certified.

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